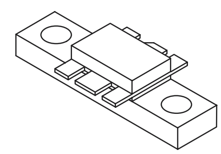
The RF Line
NPN Silicon RF Power Transistor

MRF847

**45 W, 870 MHz
RF POWER
TRANSISTOR
NPN SILICON**



CASE 319–07, STYLE 1

. . . designed for 12.5 volt UHF large–signal, **common–base** amplifier applications in industrial and commercial FM equipment operating in the range of 806–960 MHz.

- Specified 12.5 Volt, 870 MHz Characteristics
  Output Power = 45 Watts
  Power Gain = 4.5 dB Min
  Efficiency = 60% Min
- Series Equivalent Large–Signal Characterization
- Internally Matched Input for Broadband Operation
- Tested for Load Mismatch Stress at All Phase Angles with 10:1 VSWR @ High Line and Rated Drive
- Gold Metallized, Emitter Ballasted for Long Life and Resistance to Metal Migration
- Silicon Nitride Passivated

ARCHIVE INFORMATION

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector–Emitter Voltage	V_{CEO}	16.5	Vdc
Collector–Base Voltage	V_{CBO}	38	Vdc
Emitter–Base Voltage	V_{EBO}	4.0	Vdc
Collector Current — Continuous	I_C	12	Adc
Total Device Dissipation @ T_A = 25°C Derate above 25°C	P_D	150 0.85	Watts W/°C
Storage Temperature Range	T_{stg}	–65 to +150	°C
Junction Temperature	T_J	200	°C

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case	$R_{\theta JC}$	1.17	°C/W

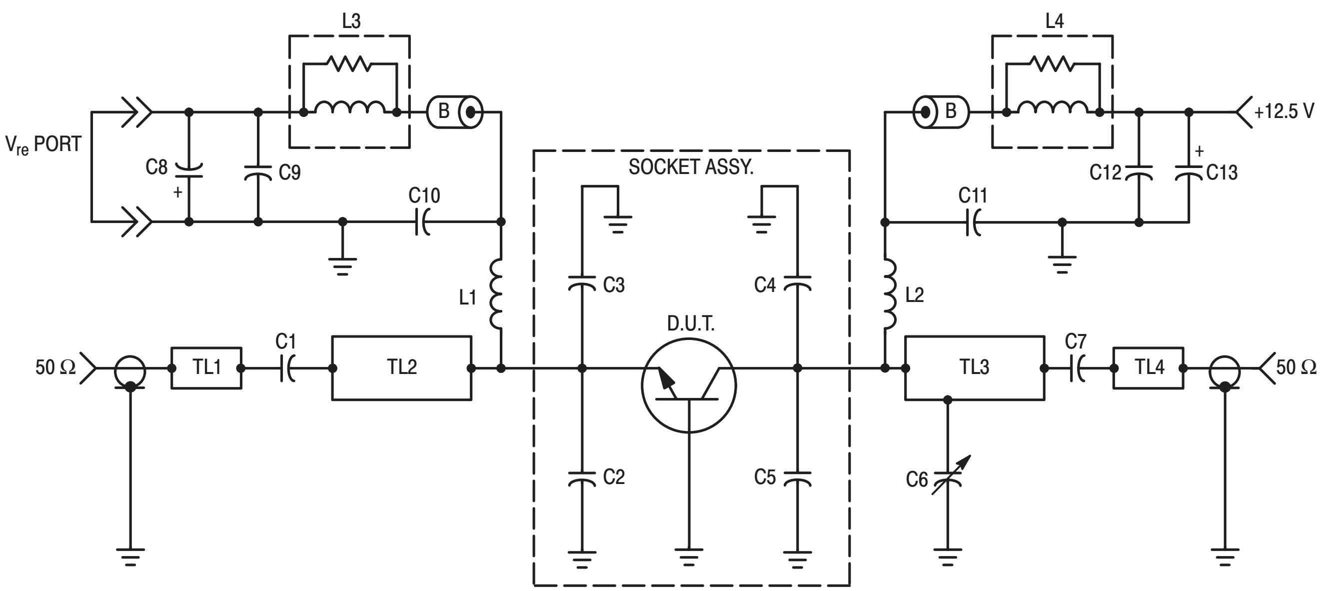
ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted.)

Characteristic	Symbol	Min	Typ	Max	Unit
OFF CHARACTERISTICS					
Emitter–Base Breakdown Voltage (I_E = 5.0 mAdc, I_C = 0)	$V_{(BR)EBO}$	4.0	—	—	Vdc
Collector–Emitter Breakdown Voltage (I_C = 50 mAdc, I_B = 0)	$V_{(BR)CEO}$	16.5	—	—	Vdc
Collector–Emitter Breakdown Voltage (I_C = 50 mAdc, V_{BE} = 0)	$V_{(BR)CES}$	38	—	—	Vdc
Collector Cutoff Current (V_{CE} = 15 Vdc, V_{BE} = 0)	I_{CES}	—	—	10	mAdc

(continued)

ELECTRICAL CHARACTERISTICS — continued (T_C = 25°C unless otherwise noted.)

Characteristic	Symbol	Min	Typ	Max	Unit
ON CHARACTERISTICS					
DC Current Gain (I_C = 2.0 Adc, V_{CE} = 5.0 Vdc)	h_{FE}	40	65	120	—
DYNAMIC CHARACTERISTICS					
Output Capacitance (V_{CB} = 12.5 Vdc, I_E = 0, f = 1.0 MHz)	C_{ob}	—	75	90	pF
FUNCTIONAL TESTS					
Common–Base Amplifier Power Gain (V_{CC} = 12.5 Vdc, P_{out} = 45 W, f = 870 MHz)	G_{PB}	4.5	5.5	—	dB
Collector Efficiency (V_{CC} = 12.5 Vdc, P_{out} = 45 W, f = 870 MHz)	η_c	60	68	—	%
Load Mismatch (V_{CC} = 15.5 Vdc, P_{in} = 16 W, f = 870 MHz, VSWR = 10:1, All Phase Angles)	ψ	No Degradation in Output Power			



C1 — 51 pF, 100 mil Chip Capacitor
C2 — 12 pF, Mini–Underwood
C3 — 11 pF, Mini–Underwood
C4, C5 — 21 pF, Mini–Underwood
C6 — 0.08–8.0 pF Johansen Gigatrim
C7 — 47 pF, 100 mil Chip Capacitor
C8, C13 — 10 µF, 25 WV Electrolytic Capacitor
C9, C12 — 1000 pF Unelco J101
C10, C11 — 91 pF Mini–Underwood
L1, L2 — 4 Turns #18 Enameled, 200 mil ID
L3, L4 — 12 Turns #22 Enameled, Wound Over 10 Ω Resistor
TL1, TL4 — 50 Ω Microstrip Line
TL2 — Microstrip (Z_o = 38 ohms, λ/4 @ 838 MHz)
TL3 — Microstrip (Z_o = 28 ohms, λ/4 @ 838 MHz)
Board Material — 0.032″ Glass–Teflon, 2 oz. cu. clad, ε_r = 2.56
B — Ferrite Bead, Ferroxcube 56–590–65–3B

Figure 1. 806–870 MHz Broadband Test Circuit

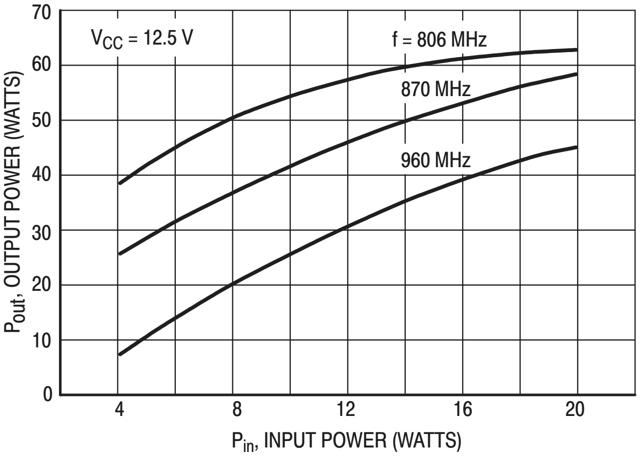


Figure 2. Output Power versus Input Power

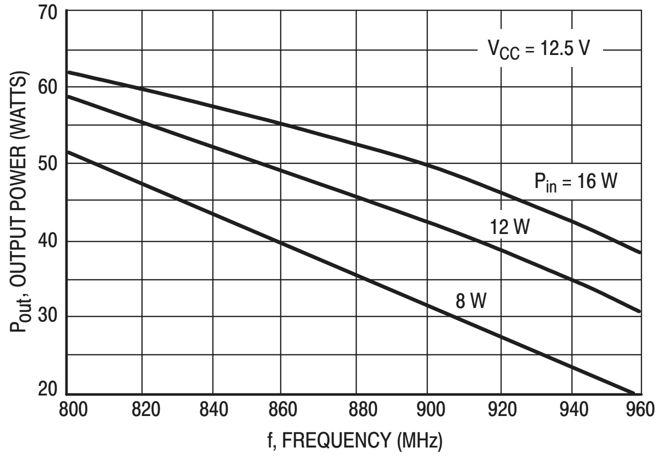


Figure 3. Output Power versus Frequency

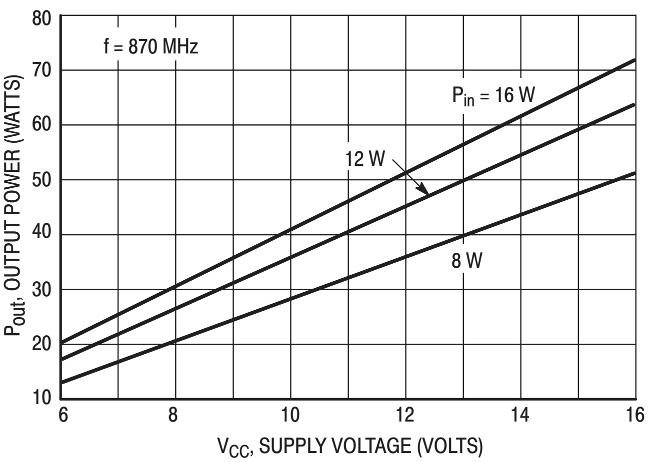


Figure 4. Output Power versus Supply Voltage

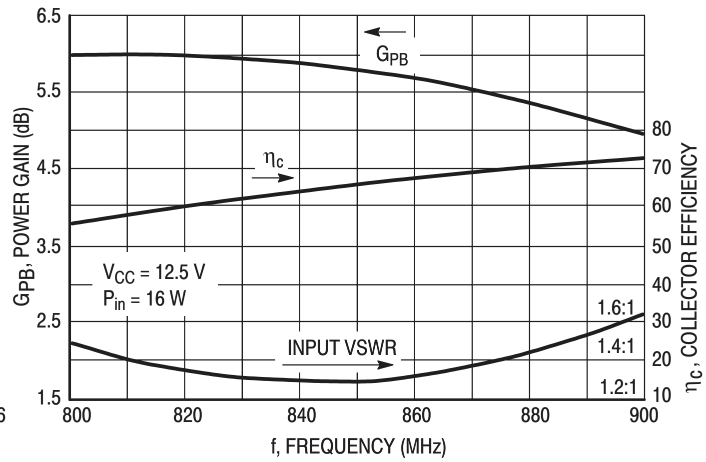
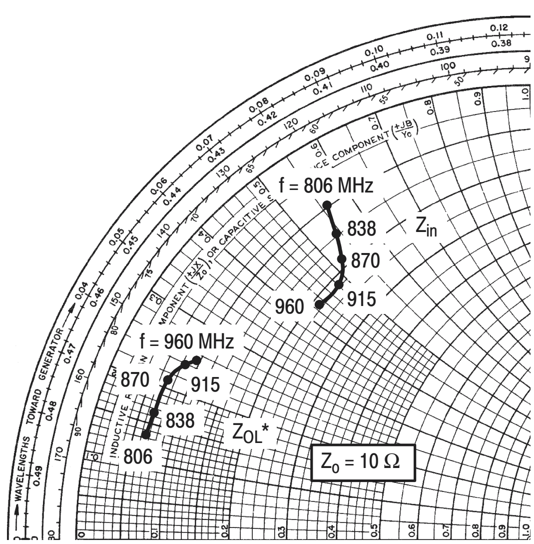


Figure 5. Typical Broadband Circuit Performance



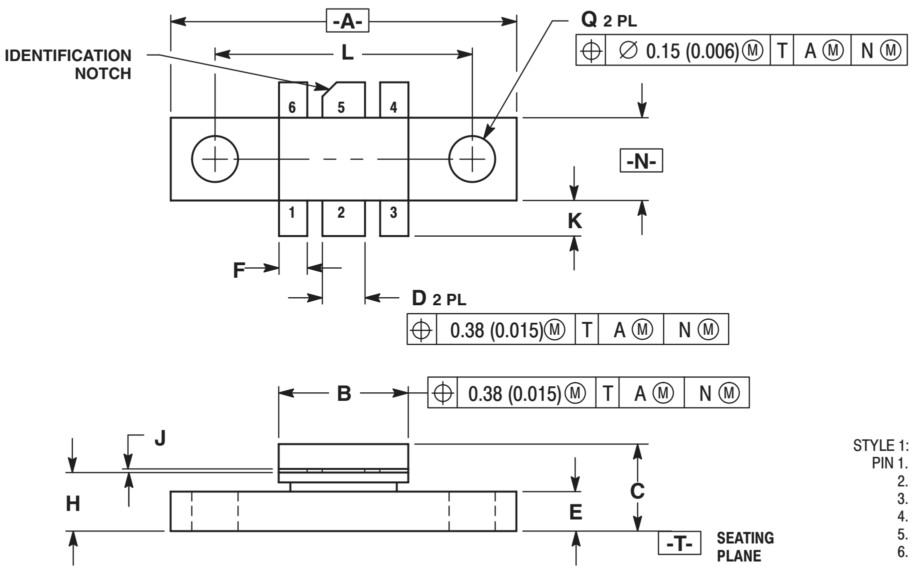
V_{CC} = 12.5 Vdc, P_{in} = 16 W, P_{out} = 45 W

f MHz	Z_{in} (Ohms)		f MHz	Z_{OL}* (Ohms)	
806	0.99	+j5.52	806	0.67	+j1.33
838	1.48	+j5.47	838	0.68	+j1.66
870	1.79	+j5.25	870	0.72	+j2.16
915	2.12	+j4.80	915	0.83	+j2.40
960	2.11	+j4.28	960	0.99	+j2.50

Z_{OL}* = Conjugate of the optimum load impedance into which the device output operates at a given output power, voltage and frequency.

Figure 6. Series Equivalent Input/Output Impedances

PACKAGE DIMENSIONS



NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.

DIM	INCHES MIN	INCHES MAX	MILLIMETER MIN	MILLIMETER MAX
A	0.965	0.985	24.52	25.01
B	0.355	0.375	9.02	9.52
C	0.230	0.260	5.85	6.60
D	0.115	0.125	2.93	3.17
E	0.102	0.114	2.59	2.90
F	0.075	0.085	1.91	2.15
H	0.160	0.170	4.07	4.31
J	0.004	0.006	0.11	0.15
K	0.090	0.110	2.29	2.79
L	0.725 BSC		18.42 BSC	
N	0.225	0.241	5.72	6.12
Q	0.125	0.135	3.18	3.42

STYLE 1:
PIN 1. BASE (COMMON)
2. EMITTER (INPUT)
3. BASE (COMMON)
4. BASE (COMMON)
5. COLLECTOR (OUTPUT)
6. BASE (COMMON)

CASE 319–07
ISSUE M

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